DELL OPTIPLEX 760

TECHNICAL GUIDEBOOK
INSIDE THE OPTIPLEX 760



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DELL[™] OPTIPLEX[™] 760

Businesses and large organizations that demand a versatile mainstream desktop solution with proven technology are ideally suited for the OptiPlex 760. The flexible OptiPlex 760 delivers reliable desktop solution to support your business's unique needs - from increased user flexibility including a diskless option to support flexible computing environments, to increased manageability, security and energy efficiency. Equipped with productivity options you can fine tune to your users needs ranging from high speed Intel® processors, generous memory options and integrated support for dual video displays, the OptiPlex 760 is an ideal mid-range solution. Data stay protected with your choice of leading-edge hardware and software security options. A range of manageability tools and desktop services to support OptiPlex systems frees up valuable IT support time. Designed with practical features, the OptiPlex 760 is just one of the reasons Dell is a leader in business desktops - and why OptiPlex is the easiest choice you'll make today.

OPTIPLEX MEANS BUSINESS

The OptiPlex 760, simple to customize with proven features designed to move your business forward:

- Long-range planning support with up to a 15-month lifecycle, stable images, globally available configurations via GSP program, managed transitions and support for legacy ports and slots
- Equipped with Intel® Core™2 Quad and Intel® Core™2 Duo Processors for outstanding productivity
- The free-for-life Dell Client Manager provides centralized remote control and automation of common system maintenance tasks
- The right fit for every user with your choice of four expandable chassis sizes

OPTIPLEX SECURITY

Offering a wide array of security options, OptiPlex gives you the power to choose your level of security:

- Identify threats earlier with Dell Client Manager support for Intel® Standard Manageability security technology
- Protect your critical data with a range of enterprise- class security options including full disk encryption hard drives, biometric finger print reader or Smart Card keyboard
- Fast and efficient control over your security features with Dell ControlPoint™

OPTIPLEX IS EASY TO OWN

OptiPlex desktops are stable, reliable and armed with a suite of highly customizable, global service and support offerings to help you throughout the PC lifecycle. For users and IT professionals alike, the OptiPlex 760 is easy to own, offering:

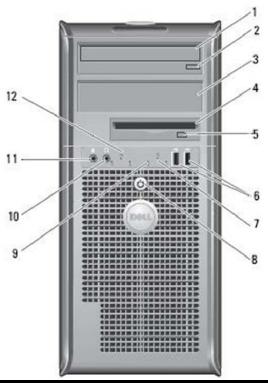
- Improved multi-tasking through integrated support for dual video displays
- Time-saving tool-less design and Dell exclusive DirectDetect troubleshooting LED's resulting in reduced maintenance and service costs
- Dell Client Manager support for Intel® Standard Manageability, allowing management for remote inventory, diagnosis & system monitoring

OPTIPLEX GETS GREEN

The OptiPlex 760 uses energy efficient technologies which can be lower the impact on the environment and your organization's energy bill:

- Help reduce power consumption—and cost—with Dell's up to 88% efficient power supplies
- Help minimize power usage with Dell Energy Smart power management technology
- Help promote environmental sensitivity with the OptiPlex 760's EPEAT Gold status

MINI TOWER COMPUTER (MT) VIEW

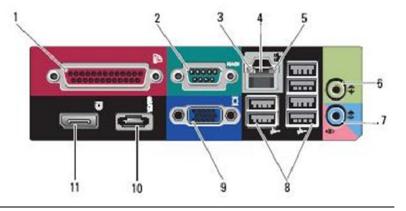


			V
FR	ONT VIEW		
1	Optical Drive	7	Hard Drive Activity Light
2	Optical Drive Eject Button	8	Power Button, Power Light
3	Optical Drive Bay (optional)	9	Diagnostic Lights (4)
4	Floppy Drive or Media Card Reader (0ptional)	10	Headphone Connector
5	Optional Floppy Drive Eject Button	11	Microphone Connector
6	USB 2.0 Connectors (2)	12	Network Connectivity Light

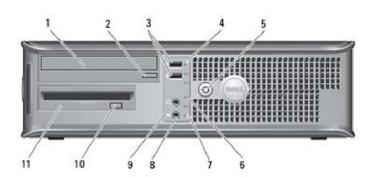


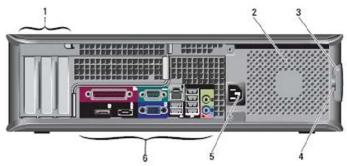
BACK VIEW			
1	Power Connector	4	Power-Supply Vent
2	Back-Panel Connectors	5	Padlock Rings
3	Expansion Card Slots (4)	6	Cover Release Latch

BACK PANEL CONNECTORS			
1	Parallel Connector	7	Line-in Connector
2	Serial Connector	8	USB 2.0 Connectors (6)
3	Link Integrity Light	9	VGA Video Connector
4	Network Connector	10	eSATA Connector
5	Network Activity Light	11	DisplayPort Connector
6	Line-out Connector		



DESKTOP COMPUTER (DT) VIEW

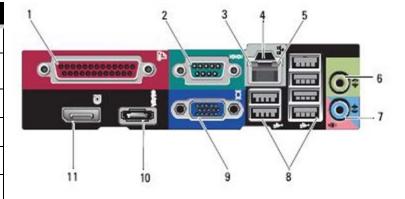




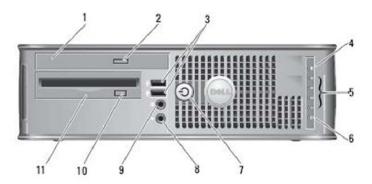
FR	FRONT VIEW			
1	Optical Drive	7	Network Connectivity Light	
2	Optical Drive Eject Button	8	Microphone Connector	
3	USB 2.0 Connectors (2)	9	Headphone Connector	
4	Hard Drive Activity Light	10	Optional Floppy Drive Eject Button	
5	Power Button, Power Light	11	Floppy Drive or Media Card Reader (optional)	
6	Diagnostic Lights (4)			

BACK VIEW			
1	Expansion Card Slots (3)	4	Padlock Rings
2	Air Vent	5	Power Connector
3	Cover Release Latch	6	Back-Panel Connectors

BA	BACK PANEL CONNECTORS			
1	Parallel Connector	7	Line-in Connector	
2	Serial Connector	8	USB 2.0 Connectors (6)	
3	Link Integrity Light	9	VGA Video Connector	
4	Network Connector	10	eSATA Connector	
5	Network Activity Light	11	DisplayPort Connector	
6	Line-out Connector			



SMALL FORM FACTOR COMPUTER (SFF) VIEW

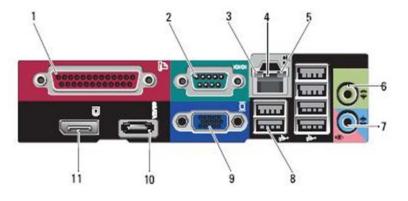




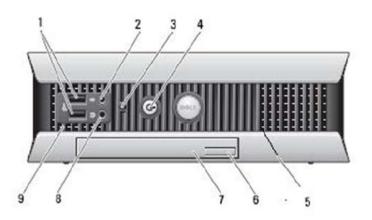
FR	ONT VIEW		
1	Optical Drive	7	Power Button, Power Light
2	Optical Drive Eject Button	8	Microphone Connector
3	USB 2.0 Connectors (2)	9	Headphone Connector
4	Network Connectivity Light	10	Optional Floppy Drive Eject Button
5	Diagnostic Lights (4)	11	Floppy Drive or Media Card Reader (optional)
6	Hard Drive Activity Light		

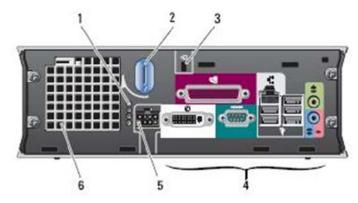
BACK VIEW			
1	Padlock Rings	4	Back-Panel Connectors
2	Cover Release Latch	5	Expansion Card Slots (2)
3	Power Connector		

ВА	BACK PANEL CONNECTORS			
1	Parallel Connector	7	Line-in Connector	
2	Serial Connector	8	USB 2.0 Connectors (6)	
3	Link Integrity Light	9	VGA Video Connector	
4	Network Connector	10	eSATA Connector	
5	Network Activity Light	11	DisplayPort Connector	
6	Line-out Connector			



ULTRA SMALL FORM FACTOR COMPUTER (USFF) VIEW

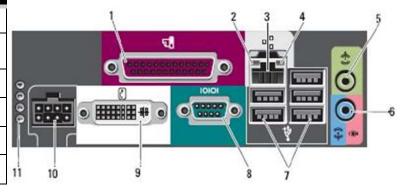




FR	ONT VIEW		
1	USB 2.0 Connectors (2)	6	Optical Drive Eject Button
2	Hard Drive Activity Light	7	Optical Drive
3	USB 2.0 Connectors (2)	8	Headphone Connector
4	Power Button, Power Light	9	Air Vents
5	Air Vents		

BACK VIEW			
1	Diagnostic Lights (4)	4	Back-Panel Connector
2	Cover Release Knob	5	Power Connector
3	Security Cable Slot	6	Air Vent

ВА	BACK PANEL CONNECTORS						
1	Parallel Connector	7	Line-in Connector				
2	Link Integrity Light	8	USB 2.0 Connectors (5)				
3	Network Connector	9	DVI Video Connector				
4	Network Activity Light	10	Power Connector				
5	Line-out Connector	11	Diagnostic Lights (4)				
6	Line-in Connector						



MARKETING SYSTEM CONFIGURATIONS

NOTE: Offerings may vary by region. For more information regarding the configuration of your computer, click Start>Help and Support and select the option to view information about your computer.

OPERATING SYSTEM

NOTE: One of the following Operating Systems will be preinstalled.

	МТ	DT	SFF	USFF	
Windows Vista® operating system	Windows Vista® Business SP1 (64 and 32 bit), Windows Vista® Ultimate (32 bit), Windows Vista® Home Basic SP1 (32 bit),				
Windows XP® operating system	Windows® XP Professional SP3 via Windows Vista® Business Downgrade Rights (32 bit), Windows® XP Home SP3 (China only)				
Other	FreeDOS for (n-series), Novell SLED (China only)				
OS Media Support	Х	Х	Х	Х	

CHIPSET

	MT	DT	SFF	USFF		
Chipset	Intel Q43 Express Chipset w/ICH10D					
Non-volatile memory on chipset						
BIOS Configuration SPI (Serial Peripheral Interface)	32Mbit (4MB) located at SPI_FLASH on chipset					
TPM 1.2 Security Device (Trusted Platform Module) ¹	16KB located at TPM1P2 on chipset					
NIC EEPROM	LOM configuration contained within SPI_FLASH – no dedicated LOI EEPROM					

PROCESSOR

NOTE: GSP (Global Standard Platform) processors are available globally and adhere to longer lifecycles to optimize product rollouts and transitions. Processor numbers are not a measure of performance.

	MT	DT	SFF	USFF
Intel® Core™ 2 Quad Processors				
Intel® Core™ 2 Quad Q9650/3.00GHz, 12M, 1333FSB	X-GSP	X-GSP	X-GSP	
Intel® Core™ 2 Quad Q9550/2.83GHz, 12M, 1333FSB	X-GSP	X-GSP	X-GSP	
Intel® Core™ 2 Quad Q9400/2.66GHz, 6M, 1333FSB	х	х	Х	
Intel® Core™ 2 Quad Q8300/2.50GHz, 4M, 1333FSB	х	х	Х	
Intel® Core™ 2 Quad Q8200/2.33GHz, 4M, 1333FSB	Х	Х	Х	
Intel® Core™ 2 Duo and Pentium® Dual Core Processors				
Intel® Core™ 2 Duo E8600/3.33GHz, 6M, 1333FSB	X-GSP	X-GSP	X-GSP	X-GSP
Intel® Core™ 2 Duo E8500/3.16GHz, 6M, 1333FSB	X-GSP	X-GSP	X-GSP	X-GSP
Intel® Core™ 2 Duo E8400/3.0GHz, 6M, 1333FSB	X-GSP	X-GSP	X-GSP	X-GSP
Intel® Core™ 2 Duo E7500/2.93GHz, 3M, 1066FSB	Х	Х	Х	Х
Intel® Core™ 2 Duo E7400/2.80GHz, 3M, 1066FSB	Х	Х	Х	Х
Intel® Core™ 2 Duo E7300/2.66GHz, 3M, 1066FSB	Х	Х	Х	Х
Intel® Core™ 2 Duo E7200/2.53GHz, 3M, 1066FSB	Х	Х	Х	Х
Intel® Pentium® Dual-Core E5300/2.60GHz, 2M, 800FSB	Х	Х	Х	Х
Intel® Pentium® Dual-Core E5200/2.50GHz, 2M, 800FSB	Х	Х	Х	Х
Intel® Pentium® Dual-Core E2220/2.40GHz, 1M, 800FSB	Х	Х	Х	Х
Intel® Pentium® Dual-Core E2200/2.20GHz, 1M, 800FSB	Х	Х	X	X
Intel® Celeron® Processors				
Intel® Celeron® Dual-Core 1500/2.20GHz, 512K, 800FSB	Х	Х	Х	Х
Intel® Celeron® Dual-Core 1400/2.00GHz, 512K, 800FSB	Х	Х	Х	Х
Intel® Celeron® 450/2.20GHz, 512K, 800FSB	Х	Х	Х	Х
Intel® Celeron® 440/2.00GHz, 512K, 800FSB	Х	Х	Х	Х

ADVANCED SYSTEM MANAGEABILITY MODES

	MT	DT	SFF	USFF
Intel® Standard Manageability	Х	Х	Х	Х
Basic Management (ASF)	Х	Х	Х	Х
Systems Management Disabled	Х	Х	Х	Х

MEMORY

Memory modules should be installed in pairs of matched memory size, speed, and technology. If the memory modules are not installed in matched pairs, the computer will continue to operate, but with a slight reduction in performance.

	MT	DT	SFF	USFF	
Type: DDR2 Synch DRAM Non-ECC Memory	800MHz				
DIMM Slots	4	4	4	2	
DIMM Capacities	Up to 2GB	Up to 2GB	Up to 2GB	Up to 2GB	
Minimum Memory	512MB	512MB	512MB	512MB	
Maximum System Memory (uses 2GB DIMMS)	8GB ¹	8GB ¹	8GB ¹	4GB ¹	
800MHz Memory configurations					
8GB ¹ DDR2 Non-ECC SDRAM, 800MHz, (4 DIMM)	Х	Х	Х		
4GB ¹ DDR2 Non-ECC SDRAM, 800MHz, (4 DIMM)	Х	Х	Х		
4GB ¹ DDR2 Non-ECC SDRAM, 800MHz, (2 DIMM)	Х	Х	Х	Х	
3GB DDR2 Non-ECC SDRAM, 800MHz, (3 DIMM)	Х	Х	Х		
3GB DDR2 Non-ECC SDRAM, 800MHz, (2 DIMM)	Х	Х	Х	Х	
2GB DDR2 Non-ECC SDRAM, 800MHz, (2 DIMM)	Х	Х	Х	Х	
2GB DDR2 Non-ECC SDRAM, 800MHz, (1 DIMM)	Х	Х	Х	Х	
1GB DDR2 Non-ECC SDRAM, 800MHz, (1 DIMM)	Х	Х	Х	Х	

¹The total amount of available memory will be less than 4GB. The amount less depends on the actual system configuration. To fully utilize 4GB or more of memory requires a 64-bit enabled processor and 64-bit operating system.

DRIVES AND REMOVABLE STORAGE

	MT	DT	SFF	USFF	
Bays:					
3.5-inch bay (External Floppy)	1	1	1 (slimline)		
5.25-inch bay (External Optical)	2	1	1 (slimline)	1 (D/bay)	
Hard Drives Supported (Internal and External)	2	1	1	1	
Optical Drives Supported	2	1	1	1 (D/bay)	
Interface:					
SATA	4	2	2	1	
Floppy Diskette	1	1	1		
3.5" Hard Drives:					
160GB ¹ SATA 10K RPM HDD	Х	Х	Х	Х	
80GB ¹ SATA 10K RPM HDD	Х	Х	Х	Х	
500GB ¹ SATA 7200 RPM HDD	Х	Х	Х	Х	
320GB ¹ SATA 7200 RPM HDD	Х	Х	Х	Х	
250GB ¹ SATA 7200 RPM HDD	Х	Х	Х	Х	
160GB ¹ SATA 7200 RPM HDD	Х	Х	Х	Х	
80GB ¹ SATA 7200 RPM HDD	Х	Х	Х	Х	
2.5" Hard Drives:					
160GB ¹ SATA Full Disk Encryption HDD	Х	Х	Х	Х	
Optical Drive: (SFF requires a slimline optical drive)					
DVD+/-RW ²	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	PATA	
DVD-ROM ³	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	РАТА	
Combo Drive CD-RW	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	PATA	
Floppy Drive:					
Floppy Drive		1.44MB			
Media Card Reader: (uses Floppy Diskette Drive slot)					
Dell 19 in 1 Media Card Reader		480Mb/s			

¹ For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

² Discs burned with this drive may not be compatible with some existing drives and players; using DVD+R media provides maximum compatibility.

 $^{^{3}}$ DVD-ROM drives may have write-capable hardware that has been disabled via firmware modifications.

SYSTEM BOARD CONNECTORS

NOTE: See Detailed Engineering Specifications for maximum card dimensions.

	MT	DT	SFF	USFF
PCI Slot(s): number of	2	2	1	
PCle x16 Slot: number of	1	1	1	
PCle x1 Slot: number of	1	0	0	
Flexbay	1	1	1	
Serial ATA (SATA)	4	2	2	1

GRAPHICS/VIDEO CONTROLLER

NOTE: MT supports full height card, DT supports low profile card or full height card with optional riser. SFF

supports low profile card.	MT	DT	SFF	USFF
Integrated Intel GMA 4500	Integrated on system board			
Enhanced Graphic/Video Options				
DVI (Digital) Adapter Card		Optional card		Native DVI
256MB ATI RADEON HD 3450 Graphics with dual DVI or VGA and S-Video Out (adapters convert to dual DVI or dual VGA)		Optional card		
256MB ATI RADEON HD 3470 Graphics with Dual DP (adapters convert to dual DVI or dual VGA)		Optional card		
256MB nVidia GeForce 9300 GE with dual DVI or VGA and S-Video Out (adapters convert to dual DVI or dual VGA)		Optional card		

EXTERNAL PORTS/CONNECTORS

NOTE: MT supports full height card, DT supports low profile card or full height card with optional riser. SFF supports low profile card.

See chassis diagrams section for port/connector locations	MT	DT	SFF	USFF		
USB 2.0	2 F	2 Front, 6 Rear, 1 Internal				
Serial	1 rear, s	1 rear, second port optional via card				
eSATA		1 Rear				
Parallel		1 F	Rear			
Network Connector (RJ-45)		1 Rear				
PS/2	0	Optional via add-in card				
1394 Controller	0	Optional via add-in card				
Video:						
VGA		1 Rear				
DVI-I	0	otional via add-in d	ard	1		
Display Port		1 Rear				
Audio:						
Line in for microphone		1 F	ront			
Line in for microphone or stereo		1 F	Rear			
Line out for headphones or speakers	1 Front, 1 Rear					
Risers: (replaces 1 PCI slot and 1 PCIe slot on DT system bo	ard)					
Combo full height riser with 1 PCI and 1 PCIe connector		X				
Dual full height riser with 2 PCI connectors		X				

COMMUNICATIONS - NETWORK ADAPTER (NIC)

NOTE: MT supports full height card, DT supports low profile card or full height card with optional riser. SFF supports low profile card.

	МТ	DT	SFF	USFF
Intel® 82567LM Gigabit ¹ Ethernet LAN 10/100/1000 (Remote Wake Up, PXE support and Intel Active Management Technology support)	Integrated on system board			
Broadcom NetXtreme 10/100/1000 PCIe Gigabit Networking Card	Optional via add-in card			

¹ This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

COMMUNICATIONS - MODEM

	МТ	DT	SFF	USFF
V.92 Data/Fax Controllerless Modem	Opt	ional via add-in d	card	

COMMUNICATIONS - WIRELESS

	MT	DT	SFF	USFF
Optional 802.11 draft-N Wi-Fi	Op	otional via add-in ca	ard	

AUDIO AND SPEAKERS

	MT	DT	SFF	USFF		
ADI 1984A High Definition Audio Codec	Integrated on system board					
Internal Chassis Speaker	Optional					
Dell AX210 USB Stereo Speakers	Optional					
Dell AX510/AX510PA Flat Panel Soundbar	Optional					

KEYBOARD AND MOUSE

	МТ	DT	SFF	USFF	
Dell USB Entry Keyboard with optional palmrest		Stand	dard		
Dell USB QuietKey Keyboard with optional palmrest	Optional				
Dell USB Multimedia Pro Keyboard	Optional				
Dell Smart Card USB Keyboard	Optional				
Dell Bluetooth Keyboard and Mouse	Optional				
Dell USB Entry Optical Mouse	Optional				
Dell Laser Mouse	Optional				
Dell Logo Mouse Pad	Optional				

SECURITY

	MT	DT	SFF	USFF		
Trusted Platform Module (TPM) 1.2 ¹	Integrated on system board					
Chassis Intrusion Switch		Opti	onal			
Dell USB External Biometric Fingerprint Reader	Optional					
Dell Smart Card USB Keyboard	Optional					
Chassis lock slot	Standard					

¹TPM not available in some countries

SERVICE AND SUPPORT

NOTE: For more details on Dell Service Plans please to go to: www.dell.com/service/service_plans

	MT	DT	SFF	USFF	
3 Year Limited Warranty ¹ (3-3-0)	Standard				
3 Year Next Business Day On-site ² Service (3-3-3)	Optional				
ProSupport	Optional				

¹ For a copy of our guarantees or limited warranties, please write Dell USA L.P., Attn: Warranties, One Dell Way, Round Rock, TX 78682. For more information, visit www.dell.com/warranty.

SOFTWARE

	MT	DT	SFF	USFF			
Dell Client Manager	Available via Dell.com						
Dell Control Point	Standard						
Norton Internet Security	90 Day Trial or Optional Subscription						
McAfee Security Center	90 Day Trial or Optional Subscription						

² Service may be provided by third-party. Technician will be dispatched if necessary following phone-based troubleshooting. Subject to parts availability, geographical restrictions and terms of service contract. Service timing dependent upon time of day call placed to Dell. U.S. only.

DETAILED ENGINEERING SPECIFICATIONS

SYSTEM DIMENSIONS (PHYSICAL)

NOTE: System Weight and Shipping Weight is based on a typical configuration and may vary based on PC configuration. A typical configuration includes: integrated graphics, one hard drive, one optical drive, and one diskette drive.

	MT	DT	SFF	USFF	
Chassis Volume (liters)	33.0	16.0	10.7	6.0	
Chassis Weight (pounds/kilograms)	25.8 / 11.7	18.2 / 8.26	15 / 6.80	10 / 4.54	
Chassis Dimensions: (HxWxD)					
Height (inches/centimeters)	16.3 / 41.4	4.5 / 11.4	3.65 / 9.26	10.3 / 26.4	
Width (inches/centimeters)	7.3 / 18.5	15.7 / 39.9	12.4 / 31.4	3.5 / 8.9	
Depth (inches/centimeters)	17.3 / 43.9	13.9 / 35.3	13.4 / 34	9.9 / 25.3	
Shipping Weight (pounds/kilograms - includes packaging materials)	43.5 / 19.73	28 / 12.7	21.3 / 9.66	26.1 / 11.84	
Packaging Parameters (HxWxD)					
Height (inches/centimeters)	22.38 / 56.85	20.63 / 52.4	20.88 / 50.04	19.88 / 50.5	
Width (inches/centimeters)	22.25 / 56.52	20.31 / 51.59	19.38 / 49.23	17.5 / 44.45	
Depth (inches/centimeters)	14.25 / 36.2	11.75 / 29.85	10.63 / 27	10.44 / 26.52	

SYSTEM BOARD CONNECTOR MAXIMUM ALLOWABLE DIMENSIONS

	MT	DT	SFF	USFF
PCI Slots	2	2	1	
Height (inches/centimeters)	4.376 / 11.115	2.731 / 6	6.89	
Length (inches/centimeters)	7.4 / 18.796*	6.6 / 16.	764	
PCIe x16 Slots	1	1	1	
Height (inches/centimeters)	4.376 / 11.115	2.731 / 6.89		
Length (inches/centimeters)	7.4 / 18.796*	6.6 / 16.764		
PCIe x1 Slots	1			
Height (inches/centimeters)	4.376/11.11 5			
Length (inches/centimeters)	7.4 / 18.796*			
Risers: (replaces 1 PCI slot and 1 PCIe slot on DT system board)				
Combo Full Height Riser with 1 PCI and 1 PCIe connector (HxL)		1		
Height (inches/centimeters)		4.376/11.11 5		
Length (inches/centimeters)*.**		6.6/16.764		
Dual Full Height Riser with 2 PCI connectors (HxL)		1		
Height (inches/centimeters)		4.376/11.11 5		
Length (inches/centimeters)*.**		6.6/16.764		

^{*} Card length can be longer than standard Half-Length Card but cannot be a Full-Length Card.

^{** 6.9/17.53} in/cm is longer than the standard Half-Length Card

SYSTEM LEVEL ENVIRONMENTAL AND OPERATING CONDITIONS

	МТ	DT	SFF	USFF	
Temperature					
Operating		10° to 35° C	(50° to 95° F)	
Non-Operating (Storage)		-40° to 65° C ((-40° to -149°	F)	
Relative Humidity	2	20% to 80% (r	non-condensir	ng)	
Maximum vibration					
Operating	0.25	G at 3 to 200	Hz at 0.5 octa	ve/min	
Non-Operating	0.5	G at 3 to 200	Hz at 1 octav	e/min	
Maximum Shock					
Operating	Bottom ha		vith a change (20 inches/sec		
Non-Operating	27-G faired square wave with a velocity change o 508 cm/sec (200 inches/sec)				
Maximum Altitude					
Operating	-15.2 to 3048 m (-50 to 10,000 ft)				
Non-Operating	-15.2 to 10,668 m (-50 to 35,000 ft)				

POWER

	MT ¹ APFC	EPA	DT ¹ APFC	EPA	SFF ¹ APFC	EPA	USFF EPA
Power Supply Wattage	305W	255W High Efficiency	255W	255 W High Efficiency	235W	235W High Efficiency	220W High Efficiency Ex- ternal PSU
AC input Voltage Range	100 to 240Vac	100 to 240Vac	100 to 240Vac	100 to 240Vac	100 to 240Vac	100 to 240Vac	100 to 240Vac
AC input current (low ac range/high AC range)	5.6A / 2.8A	3.6A / 1.8A	5.0A / 2.5A	4.0A / 2.0A	4.5A / 2.25A	3.5A / 1.75A	4.0A / 4.0A
AC input Frequency	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ
AC holdup time (80% load)	16MSEC	16MSEC	16MSEC	16MSEC	16MSEC	16MSEC	16MSEC
Average Efficiency (Energy Star Compli- ant)		88%		88%		88%	88%
Typical Efficiency (Active PFC)	70%		70%		70%		
DC parameters							
+3.3v output	8.0A	8.0A	5.0A	5.0A	5A	5A	
+5.0v output	16A	16A	15A	15A	16A	16A	
+12.0v output	12vA/15A; 12VB/10A	12VA/13A; 12VB/7A	18A	18A	17A	17A	
+5.0v auxiliary output	4.0A	4.0A	4.0	4.0	4.0A	4.0A	
-12.0v output	0.5A	0.5A	0.5A	0.5A	0.5A	0.5A	
Max total power	305W	255W	255W	255W	235W	235W	220W
Max combined +3.3v / +5.0v power	\						
Max combined 12.0v power (note: only if more than one 12v rail)	25A	20A					
BTUs/h (based on PSU max wattage)							
3.3v CMOS battery (type	and estimate	d battery life)					
Power Supply Fan	80*25mm	80*25mm	92*25mm	92*25mm	80*15mm	80*15mm	No
Compliance:							
1watt requirement	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Blue Angel Compliant	Pending	Pending	Pending	Pending	Pending	Pending	No
Climate Savers / 80Plus Compliant	No	Yes	No	Yes	No	Yes	Yes
FEMP (CECP) Standby Power Compliant	No	Yes	No	Yes	No	Yes	Yes

¹ These form factors utilize a more efficient Active Power Factor Correction (APFC) power supply. Dell recommends only Universal Power Supplies (UPS) based on Sine Wave output for APFC PSUs, not an approximation of a Sine Wave, Square Wave, or quasi-Square Wave (see UPS technical specifications). If you have questions, please contact the manufacture to confirm the output type.

AUDIO

INTEGRATED ADI 1984A HIGH DEFINITION AUDIO	MT	DT	SFF	USFF	
High Definition Stereo support	Х	Х	Х	Х	
Number of channels			2		
Number of Bits / Audio resolution		16, 20, and 2	4-bit resolutio	n	
Sampling rate (recording/playback)		Independent 8, 11.025, 16, 22.05, 32, 44.1, 48, 88.2, 96, 176.4, and 192 kHz sample rates			
Signal to Noise Ratio	96+ di	3 audio output	s, 90+ dB aud	lio inputs	
Analog Audio	Х	Х	Х	Х	
Dolby Digital					
тнх					
Digital out (S/PDIF)					
Audio Jack Impedance					
Microphone		15	0 kΩ		
Line-In		15	0 kΩ		
Line-Out		190 Ω			
Headphone		.5 Ω			
Internal Speaker Power Rating		2	2W		

COMMUNICATIONS - NETWORK ADAPTER (NIC)

NOTE: MT supports full height card, DT supports low profile card or full height card with optional riser. SFF supports low profile card.

INTEGRATED INTEL® 82567 GIGABIT1 ETHERNET LAN 10/100/1000	МТ	DT	SFF	USFF			
External Connector Type		R	J45	•			
Data Rates supported		10/100/1	000 Mbps				
Controller Details							
Controller bus architecture (example PCIe 1.0a x1)	Intel Giga		nect Interface (GL : Interface (LCI)	.CI) and			
Integrated memory		١	I/A				
Data transfer mode (example Bus-Master DMA)		١	√A				
Power consumption (full operation per data rate connection speed)		680mV	V (Max.)				
Power consumption (standby operation)	141mW (Max.)						
IEEE standards compliance (example 802.1P)		80	02.3				
Hardware Certifications (example FCC, B, GS mark)		١	I/A				
Boot ROM Support		EEPROM (I	ocated in SPI)				
Network Transfer Mode (example Full Duplex, Half Duplex)							
Network Transfer Rate (example 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps	10 Mb (full/half-duplex) 100 Mb (full/half-duplex) 1000 Mb (full-duplex)						

COMMUNICATIONS - NETWORK ADAPTER (NIC) (CONT.)

INTEGRATED INTEL® 82567 GIGABIT1 ETHERNET LAN 10/100/1000 (CONT.)	МТ	DT	SFF	USFF
Environmental				
Operating temperature	0° C to 70° C (32° F to 158° F)			
Operating humidity	20% to 80% (non-condensing)			
Operating System Driver Support	Windows® XP, Windows Vista® Ultimate, Windows Vista® Business 32 bit/64 bit, Windows Vis Home Basic			
Manageability (examples WOL, PXE)	WOL, PXE 2.1			
Management Capabilities Alerting (example ASF 2.0)	Intel® Standard Manageability, ASF 2.0			2.0

¹ This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

COMMUNICATIONS - INTEGRATED LAN

NOTE: MT supports full height card, DT supports low profile card or full height card with optional riser. SFF supports low profile card.

Broadcom NetXtreme 10/100/1000 PCIe Gigabit Networking Card	МТ	DT	SFF	USFF
Connector Type	RJ45			
Data Rates supported	10/100/1000 Mbps Half/Full duplex			
Controller Details				
Controller bus architecture (example PCIe 1.0a x1)		PCle	c1.0a x1	
Integrated memory		64KBytes R	X, 8KBytes TX	<
Data transfer mode (example Bus-Master DMA)		Bus-Ma	aster DMA	
Power consumption (full operation per data rate connection speed)	2.84W (860mA @ +3.3V)			
Power consumption (standby operation)	Less than 300mW			
IEEE standards compliance (example 802.1P)	802.3, 802.2, 802.3x, 802.1p			lp
Hardware Certifications (example FCC, B, GS mark)	FCC B, VCCI B, CE			
Boot ROM Support	No			
Network Transfer Mode (example Full Duplex, Half Duplex)	Full Duplex/Half Duplex			
Network Transfer Rate (example 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps	100BA 100BA 1000B	SE-TX (half-c ASE-TX (full-c ASE-T (full-du	uplex) 20 Mbps duplex) 100 Ml duplex) 200 Ml uplex) 2000 Ml system enviro	ops Max* opsMax* ops Max*

¹ This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

COMMUNICATIONS - INTEGRATED LAN (CONT.)

BROADCOM NETXTREME 10/100/1000 PCIE GIGABIT¹ NETWORKING CARD (CONT.)	МТ	DT	SFF	USFF
Environmental				
Operating temperature	0° C to 55° C (32° F - 131° F)			
Operating humidity	5% ~ 85% (non-condensing)			ı)
Operating System Driver Support	Windows® XP, Windows Vista® Ultimate, Windows Vista® Business 32 bit/64 bit, Windows Vista Home Basic, Linux			
Manageability (examples WOL, PXE)	WOL, PXE2.1, ACPI			
Management Capabilities Alerting (example ASF 2.0)	None			

¹ This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

COMMUNICATIONS - MODEM

V.92 DATA/FAX CONTROLLERLESS MODEM	MT	DT	SFF	USFF	
Bus		PCI			
External Connector		RJ-11			
Data Transmission		PCM - Pulse Coded Modulation (V.92/V.90) TCM - Trellis Coded Modulation (V.90/V.34/V.32 bis/ V.32)			
Data Speeds		56kbps receive,	, 48kbps transmit		
Data Standards	ľ	TU V.92/V.90, V	/.34/V.32 bis/V.32		
Fax Speeds		14.4	lkbps		
Fax Mode Capabilities		2-wire, half-dup	lex, synchronous		
Error Correction and Data Compression	V.4	14, V.42, V.42bi	s, MNP 2-4, MNP	5	
Power Management		WOR (wake o	n ring) capable		
Upgradeability		· · · · · · · · · · · · · · · · · · ·	gradeable		
Video	· ·	V.80 Synchronous Access Mode (SAM) can be sup- ported by software applications (not driver)			
Operating Temperature		0~50 degree C			
Operating Humidity		45 degree C 90% max			
Operating System Support		Vista 32/64, Windows XP 32/64			
Operating System Driver Support		Vista 32/64, Windows XP 32/64			
Power Requirements		+3.0V~+3.6V, 116.6mW max			
Chipset	Conexar	Conexant SmartHSFs/LF (CX11256 & CX20493)			
Dimensions of full height card inches/centimeters (L X H)	L: 5.25/13.32 5 H: 4.73/12.00 2				
Dimensions of low profile card inches/centimeters (L X H)			L: 5.26/13.366 H: 3.12/7.923		

GRAPHICS/VIDEO CONTROLLER

NOTE: MT supports full height card, DT supports low profile card or full height card with optional riser. SFF supports low profile card.

INTEGRATED INTEL GMA 4500	МТ	DT	SFF	USFF
Bus Type	Integrated			
GPU core clock	Gen5 core @ 667 350 MHz Integrated and with 350MHz 24 bit RAMDAC			ed and with
Frame Buffer Memory (onboard and shared) Size and Speed	XP: Up to 1GB shared system memory with 2GE system memory Vista: Up to 2GB shared system memory with 4G system memory			
Maximum power consumption			4 W	
Overlay Planes			Yes	
Maximum Color Depth		3	32 bit	
Maximum Vertical Refresh Rate		8	35 Hz	
Multiple Display Support			Yes	
Operating Systems Graphics/ Video API Support		OpenGL 2	.0/DirectX 10.0	
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or digital)	Up to 2560x11600 @ 60Hz (DP) Up to 1920x1200 @ 60Hz (DVI & VGA) Up to 1600x1200 @ 85Hz (VGA only)			& VGA)
External connectors	VGA, D	isplayPort		OVI
Environmental Operating Conditions (Non-Condensing):				
Operating Temperature Range	0° to 106° C (32° to 223° F)			·)
Relative Humidity Range	20% to 80% (non-condensing)			ıg)
Altitude Range	-15.2 to 3048 m (-50 to 10,000 ft)			00 ft)
DisplayPort (MT/DT/SFF Only)				
Bus Type		AUX 1	, 2, 4 lanes	
Maximum supported resolution		Up to 2560	x1600 @ 60Hz	
Maximum power consumption			N/A	
External connectors		Dis	playPort	
DVI (Digital) Adder Card				
Bus Type	sDVO			
Maximum supported resolution	Up to 1920x1566 @ 60 Hz			2
Dimensions of full height card inches/centimeters (L x H)	5.75x2.75ir 14.61x6.99 m			
Dimensions of low profile card inches/centimeters (L x H)			75x2.75in/ 61x6.99cm	
Maximum power consumption			N/A	
External connectors			DVI	

¹Up to 1.7 GB of system memory may be allocated to support integrated graphics, depending on operating system, system memory size and other factors.

² DVI and VGA can be used concurrently for multi-monitor display in DOS. The DisplayPort controller does not support multi-monitor display in DOS

³ Populating a discrete graphics card in the x16 slot disables onboard video.

GRAPHICS/VIDEO CONTROLLER (CONT.)

256MB AMD RADEON™ HD 3450 GRAPHICS DUAL DVI OR VGA AND TV OUT	MT	DT	SFF	
Bus Type (example integrated or PCle x16)	PCIEx16			
GPU core clock	600Mhz			
Frame Buffer Memory (onboard and shared) Size and Speed		500Mhz		
Maximum power consumption		22W		
Overlay Planes		Yes		
Maximum Color Depth		32-bit		
Maximum Vertical Refresh Rate	85Hz			
Multiple Display Support	Yes			
Operating Systems Graphics/ Video API Support	D3D and OpenGL			
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/ or digital)	Max : 1920x1440/32bpp @ 75Hz Min : 640x480/8bpp @ 60Hz			
External connectors		DMS-59 ¹ and S-vid	eo	
Dimensions of full height card inches/centimeters (L x H)	167.64mm x 120mm 167.64mm x 120m		x 120mm	
Dimensions of low profile card inches/centimeters (L x H)	167.64mm x 85mm			
Environmental Operating Conditions (Non-Condensing):				
Operating Temperature Range	10°-50° C			
Relative Humidity Range	5-90% RH			
Altitude Range		0-20,000 ft.		

¹DMS-59 to VGA or DMS-59 to DVI adaptors required.

256MB NVIDIA GEFORCE 9300 GE	MT	DT	SFF	
Bus Type (example integrated or PCle x16)	PCIEx16			
GPU core clock	540Mhz			
Frame Buffer Memory (onboard and shared) Size and Speed	500Mhz			
Maximum power consumption		25W		
Overlay Planes		Yes		
Maximum Color Depth		32-bit		
Maximum Vertical Refresh Rate	85Hz			
Multiple Display Support	Yes			
Operating Systems Graphics/ Video API Support	D3D and OpenGL			
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or digital)	Max : 1920x1440/32bpp @ 75Hz Min : 640x480/8bpp @ 60Hz			
External connectors		DMS-59 ¹ and S-vide	o	
Dimensions of full height card inches/centimeters (L x H)	167.64mm x 120mm 167.64mm x 120mm		x 120mm	
Dimensions of low profile card inches/centimeters (L x H)	167.64mm x 85mm			
Environmental Operating Conditions (Non-Condensing):				
Operating Temperature Range	10°-50° C			
Relative Humidity Range	5-90% RH			
Altitude Range	0-20,000 ft.			

¹DMS-59 to VGA or DMS-59 to DVI adaptors required.

GRAPHICS/VIDEO CONTROLLER (CONT.)

256MB AMD RADEON™ HD 3470 GRAPHICS W/ DUAL DP	MT	DT	SFF		
Bus Type (example integrated or PCle x16)	PCIEx16				
GPU core clock	750Mhz				
Frame Buffer Memory (onboard and shared) Size and Speed		500Mhz			
Maximum power consumption		18W			
Overlay Planes		Yes			
Maximum Color Depth		32-bit			
Maximum Vertical Refresh Rate	85Hz				
Multiple Display Support	Yes				
Operating Systems Graphics/ Video API Support	D3D and OpenGL				
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or digital)	Max : 1920x1440/32bpp @ 75Hz Min : 640x480/8bpp @ 60Hz				
External connectors		2 Display Port			
Dimensions of full height card inches/centimeters (L x H)	167.64mm x 120mm	167.64mm	x 120mm		
Dimensions of low profile card inches/centimeters (L x H)	167.64mm x 85mm				
Environmental Operating Conditions (Non-Condensing):	Environmental Operating Conditions (Non-Condensing):				
Operating Temperature Range	10°-50° C				
Relative Humidity Range	5-90% RH				
Altitude Range		0-20,000 ft.			

HARD DRIVES¹

3.5" 80GB SATA 7200 RPM HDD		
Capacity (bytes)	80,026,361,856	
Dimensions inches (W x D x H)	5.87 x 4 x 1	
Interface type and Maximum speed	Up to 3Gb/s	
Internal buffer size	8 MB	
Average Seek Time	8.5 ms	
Rotational Speed	7200 rpm	
Logical Blocks	156,301,488	
Power Source		
DC Power (Max)	Idle 7.0W, Active 10.0W	
DC Current	5V (.8A) and 12V (1.8A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

3.5" 160GB SATA 7200 RPM HDD			
Capacity (bytes)	160,041,885,696		
Dimensions inches (W x D x H)	5.87 x 4 x 1		
Interface type and Maximum speed	Up to 3Gb/s		
Internal buffer size	8 MB		
Average Seek Time	8.5 ms		
Rotational Speed	7200 rpm		
Logical Blocks	312,581,808		
Power Source			
DC Power (Max)	Idle 7.0W, Active 10.0W		
DC Current	5V (.8A) and 12V (1.8A)		

HARD DRIVES (CONT.)

3.5" 160GB SATA 7200 RPM HDD (CONT.)

Environmental Operating Conditions (Non-Condensing):			
5°C to 60°C			
20% to 80% non-condensing			
29°C			
-50 ft to 10000 ft			
Environmental Non-Operating Conditions (Non-Condensing):			
-40°C to 65°C			
10% to 90% non-condensing			
38°C			
-50 ft to 35000 ft			

3.5" 250GB SATA 7200 RPM HDD	
Capacity (bytes)	250,059,350,016
Dimensions inches (W x D x H)	5.87 x 4 x 1
Interface type and Maximum speed	Up to 3Gb/s
Internal buffer size	8 MB
Average Seek Time	8.5 ms
Rotational Speed	7200 rpm
Logical Blocks	488,397,168
Power Source	
DC Power (Max)	Idle 7.0W, Active 10.0W
DC Current	5V (.8A) and 12V (1.8A)
Environmental Operating Conditions (Non-Condensing):	
Temperature Range	5°C to 60°C
Relative Humidity Range	20% to 80% non-condensing
Maximum Wet Bulb Temperature	29°C
Altitude Range	-50 ft to 10000 ft
Environmental Non-Operating Conditions (Non-Condensing):	
Temperature Range	-40°C to 65°C
Relative Humidity Range	10% to 90% non-condensing
Maximum Wet Bulb Temperature	38°C
Altitude Range	-50 ft to 35000 ft

HARD DRIVES (CONT.)

320GB SATA 7200 RPM HDD (CONT.)	
Capacity (bytes)	320,072,933,376
Dimensions inches (W x D x H)	5.87 x 4 x 1
Interface type and Maximum speed	Up to 3Gb/s
Internal buffer size	16 MB
Average Seek Time	8.5 ms
Rotational Speed	7200 rpm
Logical Blocks	625,142,448
Power Source	·
DC Power (Max)	Idle 7.0W, Active 10.0W
DC Current	5V (.8A) and 12V (1.8A)
Environmental Operating Conditions (Non-Condensing):	
Temperature Range	5°C to 60°C
Relative Humidity Range	20% to 80% non-condensing
Maximum Wet Bulb Temperature	29°C
Altitude Range	-50 ft to 10000 ft
Environmental Non-Operating Conditions (Non-Condensing)	:
Temperature Range	-40°C to 65°C
Relative Humidity Range	10% to 90% non-condensing
Maximum Wet Bulb Temperature	38°C
Altitude Range	-50 ft to 35000 ft

3.5" 80GB SATA 10000 RPM HDD	
Capacity (bytes)	80,026,361,856
Dimensions inches (W x D x H)	5.87 x 4 x 1 (includes sled)
Interface type and Maximum speed	Up to 3Gb/s
Internal buffer size	16 MB
Average Seek Time	4.6 ms (average read)
Rotational Speed	10000 rpm
Logical Blocks 156,301,488	
Power Source	
DC Power (Max)	Idle 7W, Active 10W
DC Current	5V (.8A) and 12V (1.8A)

HARD DRIVES (CONT.)

3.5" 80GB SATA 10000 RPM HDD (CONT.)		
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

3.5" 160GB SATA 10000 RPM HDD		
Capacity (bytes)	160,041,885,696	
Dimensions inches (W x D x H)	5.87 x 4 x 1 (includes sled)	
Interface type and Maximum speed	Up to 3Gb/s	
Internal buffer size	16 MB	
Average Seek Time	4.6 ms (average read)	
Rotational Speed	10000 rpm	
Logical Blocks	312,581,808	
Power Source		
DC Power (Max)	Idle 7W, Active 10W	
DC Current	5V (.8A) and 12V (1.8A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

HARD DRIVES (CONT.)

Capacity (bytes) Dimensions inches (W x D x H) Interface type and Maximum speed Internal buffer size Average Seek Time Rotational Speed Logical Blocks Power Source DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range	
Interface type and Maximum speed Internal buffer size Average Seek Time Rotational Speed Logical Blocks Power Source DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	160,041,885,696
Internal buffer size Average Seek Time Rotational Speed Logical Blocks Power Source DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	5.87 x 4 x 1
Average Seek Time Rotational Speed Logical Blocks Power Source DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	Up to 3Gb/s
Rotational Speed Logical Blocks Power Source DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	8 MB
Logical Blocks Power Source DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	8.5 ms
Power Source DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	7200 rpm
DC Power (Max) DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	312,581,808
DC Current Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	
Environmental Operating Conditions (Non-Condensing): Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	Idle 7W, Active 10W
Temperature Range Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	5V (.8A) and 12V (1.8A)
Relative Humidity Range Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	
Maximum Wet Bulb Temperature Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	50°C to 600°C
Altitude Range Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	20% to 80% non-condensing
Environmental Non-Operating Conditions (Non-Condensing): Temperature Range	29°C
Temperature Range	-50 ft to 10000 ft
· · · · · · · · · · · · · · · · · · ·	
Relative Humidity Range	-40°C to 65°C
reduite Hamary range	10% to 90% non-condensing
Maximum Wet Bulb Temperature	2202
Altitude Range	38°C

¹ For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

OPTICAL DRIVES

DVD +/- RW ¹	MT	DT	SFF	USFF
External Dimensions inches/centimeters (Without Bezel – W x H x D)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)
Weight (max) pounds/ kilograms	800g	800g	170g	170g
Interface type and speed	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	PATA
Disc Capacity	Standard	Standard	Standard	Standard
Internal buffer size	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Access Times (typical)	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Maximum Data Transfer Ra	ates			
Writes	16x DVD/48x CD	16x DVD/48x CD	8x DVD/ 24x CD	8x DVD/ 24x CD
Reads	16x DVD/48x CD	16x DVD/48x CD	8x DVD/ 24x CD	8x DVD/ 24x CD
Power Source				
DC Power Requirements	12V, 5V	12V, 5V	5V	5V
DC Current	1200mA (12V)/ 900mA (5V)	1200mA (12V)/ 900mA (5V)	1000mA	1000mA
Environmental Operating (Environmental Operating Conditions (Non-Condensing):			
Operating Temperature Range	5C to 50C	5C to 50C	5C to 50C	5C to 50C
Relative Humidity Range	20% to 80% RH	20% to 80% RH	20% to 80% RH	20% to 80% RH
Maximum Wet Bulb Temperature	29C	29C	29C	29C
Altitude Range	-200 to 3048	-200 to 3048	-200 to 3048	-200 to 3048
Environmental Non-Operating Conditions (Non-Condensing):				
Operating Temperature Range	-40C to 65C	-40C to 65C	-40C to 65C	-40C to 65C
Relative Humidity Range	5% to 95% RH	5% to 95% RH	5% to 95% RH	5% to 95% RH
Maximum Wet Bulb Temperature	38C	38C	38C	38C
Altitude Range	-200 to 10600m	-200 to 10600m	-200 to 10600m	-200 to 10600m

¹ Discs burned with this drive may not be compatible with some existing drives and players; using DVD+R media provides maximum compatibility.

DVD-ROM	MT	DT	SFF	USFF
External Dimensions inches/centimeters (Without Bezel – W x H x D)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)
Weight (max) pounds/ kilograms	750g	750g	165g	165g
Interface type and speed	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	PATA
Disc Capacity	Standard	Standard	Standard	Standard
Internal buffer size	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Access Times (typical)	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Maximum Data Transfer Rates				
Writes	N/A	N/A	N/A	N/A
Reads	16x DVD/48x CD	16x DVD/48x CD	8x DVD/ 24x CD	8x DVD/ 24x CD

OPTICAL DRIVES (CONT.)

DVD-ROM (CONT.)	МТ	DT	SFF	USFF
Power Source	1111		0.1	00.1
DC Power Requirements	12V, 5V	12V, 5V	5V	5V
DC Current	1200mA (12V)/ 900mA	1200mA (12V)/ 900mA	800mA	800mA
	Environmental Operating Conditions (Non-Condensing):			
Operating Temperature	T			
Range	5C to 50C	5C to 50C	5C to 50C	5C to 50C
Relative Humidity Range	20% to 80% RH	20% to 80% RH	20% to 80% RH	20% to 80% RH
Maximum Wet Bulb Temperature	29C	29C	29C	29C
Altitude Range	-200 to 3048m	-200 to 3048m	-200 to 3048m	-200 to 3048m
Environmental Non-Operat	ing Conditions (Non-Conden	sing):		
Operating Temperature Range	-40C to 65C	-40C to 65C	-40C to 65C	-40C to 65C
Relative Humidity Range	5% to 95% RH	5% to 95% RH	5% to 95% RH	5% to 95% RH
Maximum Wet Bulb Temperature	38C	38C	38C	38C
Altitude Range	-200 to 10600m	-200 to 10600m	-200 to 10600m	-200 to 10600m
	,			
COMBO DVD/ CDRW	MT	DT	SFF	USFF
External Dimensions inches/centimeters (Without Bezel – W x H x D)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)
Weight (max) pounds/ kilograms	750g	750g	165g	165g
Interface type and speed	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	PATA
Disc Capacity	Standard	Standard	Standard	Standard
Internal buffer size	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Access Times (typical)	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Maximum Data Transfer Ra	ates			
Writes	48x CD	48x CD	24x CD	24x CD
Reads	16x DVD/48x CD	16x DVD/48x CD	8x DVD/ 24x CD	8x DVD/ 24x CD
Power Source				
DC Power Requirements	12V, 5V	12V, 5V	5V	5V
DC Current	1200mA (12V)/ 900mA (5V)	1200mA (12V)/ 900mA (5V)	900mA	900mA
Environmental Operating O	Conditions (Non-Condensing):		
Operating Temperature Range	5C to 50C	5C to 50C	5C to 50C	5C to 50C
Relative Humidity Range	20% to 80% RH	20% to 80% RH	20% to 80% RH	20% to 80% RH
Maximum Wet Bulb Temperature	29C	29C	29C	29C
Altitude Range	-200 to 3048m	-200 to 3048m	-200 to 3048m	-200 to 3048m
·	Environmental Non-Operating Conditions (Non-Condensing):			
Operating Temperature Range	-40C to 65C	-40C to 65C	-40C to 65C	-40C to 65C
Relative Humidity Range	5% to 95% RH	5% to 95% RH	5% to 95% RH	5% to 95% RH
Maximum Wet Bulb Temperature	38C	38C	38C	38C
Altitude Range	-200 to 10600m	-200 to 10600m	-200 to 10600m	-200 to 10600m

BIOS DEFAULTS

Drives	Diskette drive:	USB
	SATA Operation;	AHCI
	SMART Reporting:	Disable
	SATA-0:	Enable
	SATA-1:	Enable
	External SATA:	Enable
System Configuration	Integrated NIC:	Enable
	USB Controller:	Enable
	Parallel Port:	PS/2
	Parallel Port Address:	378h
	Serial Port #1:	Auto
	Serial Port #2:	Auto
	Front USB:	Enable
	Rear Quad USB:	Enable
	Rear Dual USB:	Enable
	PCI Slots:	Enable
	Audio:	Enable
Video	Primary Video:	Auto
Performance	Multiple CPU Core:	Enable
i ci o i i i i i i i i ci		
Chomanoe	Intel® SpeedStep™:	Disable, unless the customer purchased a SpeedStep™ capable processor.
Tonomanoe		
1 chamarios	Intel® SpeedStep™:	SpeedStep™ capable processor.
Tonomanoe	Intel® SpeedStep™: C States Control:	SpeedStep™ capable processor. Enable
	Intel® SpeedStep™: C States Control: Limit CPUID Value:	SpeedStep™ capable processor. Enable Disable Bypass
Virtualization Support	Intel® SpeedStep™: C States Control: Limit CPUID Value:	SpeedStep™ capable processor. Enable Disable
	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode:	SpeedStep™ capable processor. Enable Disable Bypass
	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode: Virtualization:	SpeedStep™ capable processor. Enable Disable Bypass Disable
	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode: Virtualization:	SpeedStep™ capable processor. Enable Disable Bypass Disable
Virtualization Support	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode: Virtualization: VT for Direct I/O:	SpeedStep™ capable processor. Enable Disable Bypass Disable Disable Disable
Virtualization Support	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode: Virtualization: VT for Direct I/O: Administrator Password:	SpeedStep™ capable processor. Enable Disable Bypass Disable Disable Not set
Virtualization Support	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode: Virtualization: VT for Direct I/O: Administrator Password: System Password:	SpeedStep™ capable processor. Enable Disable Bypass Disable Disable Not set Not set
Virtualization Support	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode: Virtualization: VT for Direct I/O: Administrator Password: System Password: Password Changes:	SpeedStep™ capable processor. Enable Disable Bypass Disable Disable Not set Not set Enable
Virtualization Support	Intel® SpeedStep™: C States Control: Limit CPUID Value: HDD Acoustic Mode: Virtualization: VT for Direct I/O: Administrator Password: System Password: Password Changes: TPM Security:	SpeedStep™ capable processor. Enable Disable Bypass Disable Disable Not set Not set Enable Disable Disable

BIOS DEFAULTS (CONT.)

	,	
Power Management	AC Recovery:	Power Off
	Auto On Time:	Disable
	Low Power Mode:	Disable
	Remote Wake Up:	Disable
	Suspend Mode:	S3
	Fan Control Override:	Disable
Maintenance	Service Tag:	Set by the factory
	Asset Tag:	Optional User Entry
	SERR Message:	Enable
Post Behavior	Fast Boot:	Enable
	Numlock LED:	Enable
	POST HotKeys:	Enable
	Keyboard Errors:	Enable
	MEBx HotKey	Enable

CHASSIS ENCLOSURE & VENTILATION REQUIREMENTS

ENCLOSURE VENTILATION

If your enclosure has doors, they need to be of a type that allows at least 30% airflow through the enclosure (front and back).

ENCLOSURE MINIMUM CLEARANCE

Leave a 10.2 cm (4 in.) minimum clearance on all vented sides of the computer to permit the airflow required for proper ventilation.

RECOMMENDED ENCLOSURE

Do not install your computer in an enclosure that does not allow airflow. This restricts the airflow and impacts your computer's performance, possibly causing it to overheat.



OPEN DESK MINIMUM CLEARANCE

If your computer is installed in a corner, on a desk, or under a desk, leave at least 5.1 cm (2 in.) clearance from the back of the computer to the wall to permit the airflow required for proper ventilation.



REGULATORY COMPLIANCE AND ENVIRONMENTAL

Product related conformity assessment and regulatory authorizations including Product Safety, Electromagnetic Compatibility (EMC), Ergonomics, and Communication Devices relevant to this product may be viewed at www.dell.com/regulatory_compliance. The Regulatory Datasheet for this product is located at http://www.dell.com/regulatory_compliance.

Details of Dell's environmental stewardship program to conserve product energy consumption, reduce or eliminate materials for disposal, prolong product life span and provide effective and convenient equipment recovery solutions may be viewed at www.dell.com/environment. Product related conformity assessment, regulatory authorizations, and information encompassing Environmental, Energy Consumption, Noise Emissions, Product Materials Information, Packaging, Batteries, and Recycling relevant to this product may be viewed by clicking the Design for Environment link on the webpage.

ACOUSTIC NOISE EMISSION INFORMATION

OPTIPLEX 760 MT

Component	Typical Configuration	High-end Configuration
CPU	E7200	Q9650
Memory	512MB DDRII 667MHz (x2)	2GB DDRII 800 MHz (x4)
HDD (#, capacity)	80 GB 7200 RPM SATA2	250 GB 7200 RPM SATA2 (x2)
RMSD	DVDRW/DVD dual config	DVDRW/DVD dual config
Graphics Adapter	Integrated GMA3100	ATI RADEON HD 2400 XT

The Declared Noise Emission in accordance with ISO 9296 for the Dell Optiplex 760 MT is as follows: (all values L_{WAd} expressed in bels; 1 bel=10 decibels, re 10⁻¹² Watts)

Operating Mode	Typical Configuration Declared Sound Power (L _{WAd})	High-end Configuration Declared Sound Power (L _{WAd})
Idle	3.7	4.4
HDD Operating	3.7	4.4
90% CPU	4.0	4.5
ODD Operating	5.1	5.1

The Declared A-weighted Sound Pressure Level in decibels (re 2x10⁻⁵ Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows¹:

Operating Mode	Typical Configuration Declared Sound Pressure (LpA)				High-end Configuration Declared Sound Pressure (LpA)			
	Table-Top Floor-Standing			Table	-Тор	Floor- Standing		
	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	By- stander Position (LpA)
Idle	26.7	22.9	22.0	20.7	36.9	30.3	28.1	27.9
HDD Operating	26.9	23.2	22.2	20.9	36.0	29.0	29.0	28.7
90% CPU	31.6	27.1	23.2	22.6	37.4	31.6	30.0	29.4
ODD Operating	41.1	35.6	36.0	33.5	42.5	35.5	35.7	34.2

¹ All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes. ² Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

ACOUSTIC NOISE EMISSION INFORMATION

OPTIPLEX 760 DT

Component	Typical Configuration	High-end Configuration		
CPU	E7200	Q9650		
Memory	512MB DDRII 667MHz (x2)	2GB DDRII 800 MHz (x4)		
HDD (#, capacity)	80 GB 7200 RPM SATA2	250 GB 7200 RPM SATA2 (x1)		
RMSD	DVDRW/DVD dual config	DVDRW/DVD dual config		
Graphics Adapter	Integrated GMA3100	ATI RADEON HD 2400 XT		

The Declared Noise Emission in accordance with ISO 9296 for the Dell Optiplex 760 DT is as follows: (all values L_{WAd} expressed in bels; 1 bel=10 decibels, re 10⁻¹² Watts)

Operating Mode	Typical Configuration Declared Sound Power (L _{WAd})	High-end Configuration Declared Sound Power (L _{WAd})		
Idle	3.7	4.1		
HDD Operating	3.7	4.1		
90% CPU	3.7	4.4		
ODD Operating	5.2	5.2		

The Declared A-weighted Sound Pressure Level in decibels (re $2x10^{-5}$ Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows¹:

Operating Mode	Typical Configuration Declared Sound Pressure (LpA)				High-end Configuration Declared Sound Pressure (LpA)			
	Table-Top Floor-Standing			Table	е-Тор	Floor- Standing		
	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	By- stander Position (LpA)
Idle	28.0	22.8	22.1	20.8	31.4	25.4	23.1	21.4
HDD Operating	28.2	23.0	22.0	20.6	32.0	26.1	24.1	22.2
90% CPU	28.0	22.6	22.1	20.5	37.4	28.6	25.8	23.9
ODD Operating	41.5	37.2	35.9	33.3	42.5	36.8	34.4	33.5

¹ All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes.

² Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

ACOUSTIC NOISE EMISSION INFORMATION

OPTIPLEX 760 SFF

Component	Typical Configuration	High-end Configuration		
CPU	E7200	Q9650		
Memory	512MB DDRII 667MHz (x2)	2GB DDRII 800MHz (x4)		
HDD (#, capacity)	80 GB 7200 RPM SATA2	250 GB 7200 RPM SATA2 (x1)		
RMSD	DVDRW/DVD dual config	DVDRW/DVD dual config		
Graphics Adapter	Integrated GMA3100	ATI RADEON HD 2400 XT		

The Declared Noise Emission in accordance with ISO 9296 for the Dell Optiplex 760 SFF is as follows: (all values L_{WAd} expressed in bels; 1 bel=10 decibels, re 10^{-12} Watts)

Operating Mode	Typical Configuration Declared Sound Power (L _{WAd})	High-end Configuration Declared Sound Power (L _{WAd})		
Idle	3.7	4.2		
HDD Operating	3.7	4.3		
90% CPU	4.1	4.7		
ODD Operating	4.9	4.8		

The Declared A-weighted Sound Pressure Level in decibels (re 2x10⁻⁵ Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows¹:

Operating Mode	Typical Configuration Declared Sound Pressure (LpA)				High-end Configuration Declared Sound Pressure (LpA)			
	Table-Top Floor-Standing			Table	-Тор	Floor- Standing		
	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)
Idle	26.9	22.6	21.9	21.1	34.6	27.8	24.9	23.8
HDD Operating	26.5	22.5	22.1	21.2	35.1	28.3	25.1	24.1
90% CPU	31.8	28.7	23.2	23.0	38.2	31.7	29.5	27.7
ODD Operating	42.8	39.8	36.6	35.4	40.0	33.8	31.8	30.4

¹ All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes.

² Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

ACOUSTIC NOISE EMISSION INFORMATION

OPTIPLEX 760 USFF

Component	Typical Configuration	High-end Configuration		
CPU	E7200	E8400		
Memory	1 GB DDR2 667 MHz	2 GB DDR2 800 MHz		
HDD (#, capacity)	80 GB 3.5" 7200 RPM SATA2	160 GB 3.5" 7200 RPM SATA2		
RMSD	DVD +/- RW	DVD +/- RW		
Graphics Adapter	Intel Integrated Adapter	Intel Integrated Adapter		

The Declared Noise Emission in accordance with ISO 9296 for the Dell Optiplex 760 USFF is as follows: (all values L_{WAd} expressed in bels; 1 bel=10 decibels, re 10⁻¹² Watts)

Operating Mode	Typical Configuration Declared Sound Power (L _{WAd})	High-end Configuration Declared Sound Power (L _{WAd})		
Idle	3.9	4.0		
HDD Operating	3.9	3.9		
ODD Operating	4.7	4.9		
90% CPU	3.9	3.9		

The Declared A-weighted Sound Pressure Level in decibels (re 2x10⁻⁵ Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows1:

On anating Made	Ty Declar	/pical Configuration	on re (L _{pA})	High-end Configuration Declared Sound Pressure (L _{pA})			
Operating Mode	Operator Position (L _{pA})	Bystander Position (L _{pA})	DeskSide Position (L _{pA})	Operator Position (L _{pA})	Bystander Position (L _{pA})	DeskSide Position (L _{pA})	
Idle	30	28	25	32	28	22	
HDD Operating	30	28	25	32	28	22	
ODD Operating	38	33	31	42	35	26	
90% CPU	29	27	25	32	28	24	

¹ All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes.

² Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2